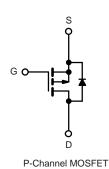


DMG3415U-7-F-VB Datasheet

P-Channel 30 V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}$ (Ω) Typ.	I _D (A) ^a	Q _g (Typ.)			
	0.046 at V _{GS} = - 10 V	- 5.6				
- 30	0.049 at V _{GS} = - 6 V	- 5	11.4 nC			
	0.054 at V _{GS} = - 4.5 V	-4.5				





FEATURES

- TrenchFET® Power MOSFET • 100 % R_g Tested

HALOGEN FREE

- For Mobile Computing
 - Load Switch

APPLICATIONS

- Notebook Adaptor Switch
- DC/DC Converter

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	- 30	.,,
Gate-Source Voltage		V_{GS}	± 20	V
	T _C = 25 °C	I _D	- 5.6	
Continuous Dunin Comment (T., 450 °C)	T _C = 70 °C		- 5.1	
Continuous Drain Current (T _J = 150 °C)	T _A = 25 °C		- 5.4 ^{b,c}	
	T _A = 70 °C		- 4.3 ^{b,c}	Α
Pulsed Drain Current (t = 100 µs)		I _{DM}	- 18	
Continous Source-Drain Diode Current	T _C = 25 °C	- I _S	- 2.1	
	T _A = 25 °C		- 1 ^{b,c}	
Maximum Power Dissipation	T _C = 25 °C	P _D	2.5	
	T _C = 70 °C		1.6	10/
	T _A = 25 °C		1.25 ^{b,c}	W
	T _A = 70 °C	1	0.8 ^{b,c}	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C

THERMAL RESISTANCE RATINGS								
Parameter		Symbol	Typical	Maximum	Unit			
Maximum Junction-to-Ambient ^{b,d}	t ≤ 5 s	R _{thJA}	75	100	°C/W			
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	40	50	C/VV			

Notes:

- a. Based on T_C = 25 °C. b. Surface mounted on 1" x 1" FR4 board.
- c. t = 5 s.
- d. Maximum under steady state conditions is 166 °C/W.

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static				·		
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	- 30			V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	J 250 A		- 19		mV/°C
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = - 250 μA		4		
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_{D} = -250 \mu A$	- 0.5		- 2.0	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
		V _{DS} = - 30 V, V _{GS} = 0 V			- 1	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 30 V, V _{GS} = 0 V, T _J = 55 °C			- 5	μA
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le -5 \text{ V}, V_{GS} = -10 \text{ V}$	- 2.5			Α
	. ,	$V_{GS} = -10 \text{ V}, I_D = -4.4 \text{ A}$		0.046		
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} =- 6 V, I _D = - 4 A		0.049		Ω
	-(-,	V _{GS} =- 4.5 V, I _D = - 3.6 A		0.054		1
Forward Transconductance ^a g_{fs} $V_{DS} = -15 \text{ V}, I_{D}$		V _{DS} = - 15 V, I _D = - 3.4 A		18		S
Dynamic ^b		-		Į		
Input Capacitance	C _{iss}			1295		pF
Output Capacitance	C _{oss}	V _{DS} = - 15 V, V _{GS} = 0 V, f = 1 MHz		150		
Reverse Transfer Capacitance	C _{rss}			130		
		V _{DS} = - 15 V, V _{GS} = - 10 V, I _D = - 5.4 A		24 36		-
Total Gate Charge	Q_g	D3 - 7 G3 - 7 D -		11.4	17	nC
Gate-Source Charge	Q _{gs}	V _{DS} = - 15 V, V _{GS} = - 4.5 V, I _D = - 5.4 A		3.4		
Gate-Drain Charge	Q _{gd}			3.8		
Gate Resistance	R _g	f = 1 MHz	1.5	7.7	15.4	Ω
Turn-On Delay Time	t _{d(on)}			13	20	
Rise Time	t _r	$V_{DD} = -15 \text{ V}, R_{I} = 3.5 \Omega$		4	8	1
Turn-Off Delay Time	t _{d(off)}	$I_D \cong -4.3 \text{ A}, V_{GEN} = -10 \text{ V}, R_g = 1 \Omega$		38	57	-
Fall Time	t _f	j		6	12	-
Turn-On Delay Time	t _{d(on)}			28	42	ns
Rise Time	t _r	$V_{DD} = -15 \text{ V}, R_{L} = 3.5 \Omega$		16	24	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong -4.3 \text{ A}, V_{GEN} = -4.5 \text{ V}, R_g = 1 \Omega$		30	45	
Fall Time	t _f			10	20	-
Drain-Source Body Diode Characteristic	· · · · · · · · · · · · · · · · · · ·					
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			- 2.1	
Pulse Diode Forward Current (t = 100 μs)	I _{SM}	-			- 80	A
Body Diode Voltage	V _{SD}	I _S = - 4.3 A, V _{GS} = 0 V		- 0.8	- 1.2	V
Body Diode Reverse Recovery Time	t _{rr}	<u> </u>		15	23	ns
Body Diode Reverse Recovery Charge	Q _{rr}			7	14	nC
Reverse Recovery Fall Time	t _a	$I_F = -4.3 \text{ A, dI/dt} = 100 \text{ A/}\mu\text{s, T}_J = 25 ^{\circ}\text{C}$		8	<u> </u>	ns
Reverse Recovery Rise Time	t _b	 		7	 	

Notes

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

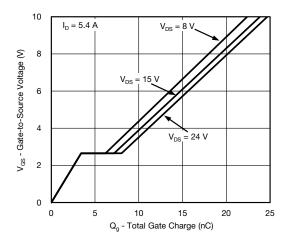




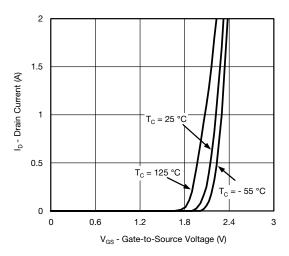
Output Characteristics



On-Resistance vs. Drain Current



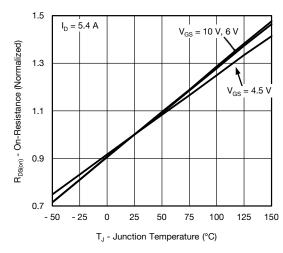
Gate Charge



Transfer Characteristics



Capacitance

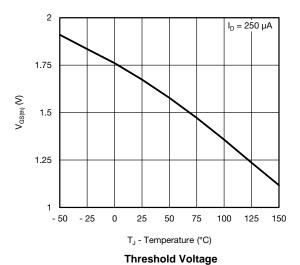


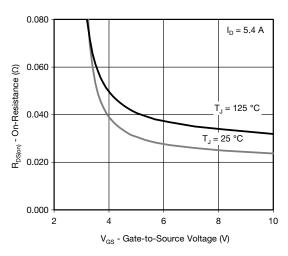
On-Resistance vs. Junction Temperature



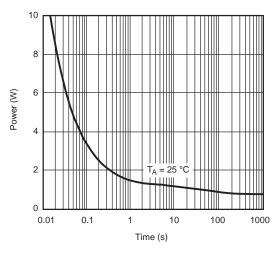


Source-Drain Diode Forward Voltage

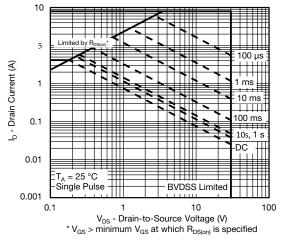




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power (Junction-to-Ambient)

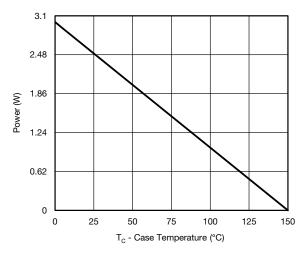


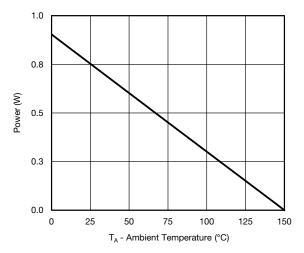
Safe Operating Area, Junction-to-Ambient





Current Derating*

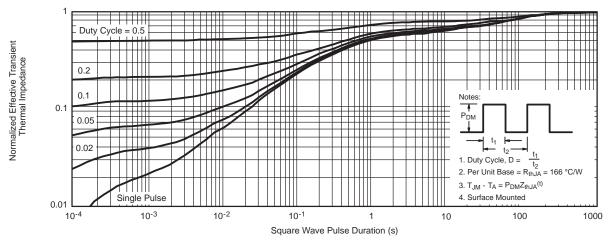




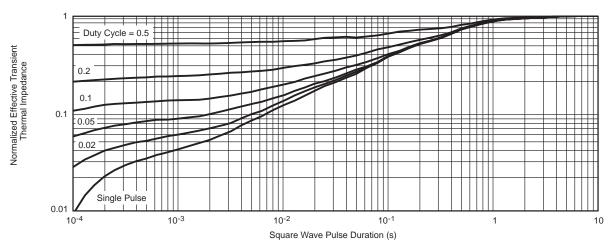
Power, Junction-to-Foot Power, Junction-to-Ambient

 $^{^{\}star}$ The power dissipation P_D is based on T_{J(max.)} = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





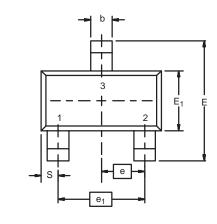
Normalized Thermal Transient Impedance, Junction-to-Ambient

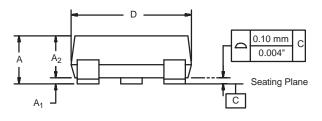


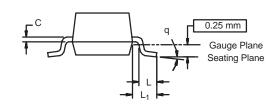
Normalized Thermal Transient Impedance, Junction-to-Foot



SOT-23 (TO-236): 3-LEAD







Min 0.89	Max 1.12	Min	Max	
0.89	1 10		max	
	1.12	0.035	0.044	
0.01	0.10	0.0004	0.004	
0.88	1.02	0.0346	0.040	
0.35	0.50	0.014	0.020	
0.085	0.18	0.003	0.007	
2.80	3.04	0.110	0.120	
2.10	2.64	0.083	0.104	
1.20	1.40	0.047	0.055	
0.95 BSC		0.0374 Ref		
1.90 BSC		0.0748 Ref		
0.40	0.60	0.016	0.024	
0.64 Ref		0.025 Ref		
0.50 Ref		0.020 Ref		
3°	8°	3°	8°	
	0.88 0.35 0.085 2.80 2.10 1.20 0.95 1.90 0.40 0.62 0.50 3°	0.88 1.02 0.35 0.50 0.085 0.18 2.80 3.04 2.10 2.64 1.20 1.40 0.95 BSC 1.90 BSC 0.40 0.60 0.64 Ref 0.50 Ref	0.88 1.02 0.0346 0.35 0.50 0.014 0.085 0.18 0.003 2.80 3.04 0.110 2.10 2.64 0.083 1.20 1.40 0.047 0.95 BSC 0.0374 1.90 BSC 0.0748 0.40 0.60 0.016 0.64 Ref 0.025 0.50 Ref 0.020 3° 8° 3°	

ECN: S-03946-Rev. K, 09-Jul-01

DWG: 5479



RECOMMENDED MINIMUM PADS FOR SOT-23



Recommended Minimum Pads Dimensions in Inches/(mm)

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